



TaiSol Electronics Co., Ltd.

Investor Conference

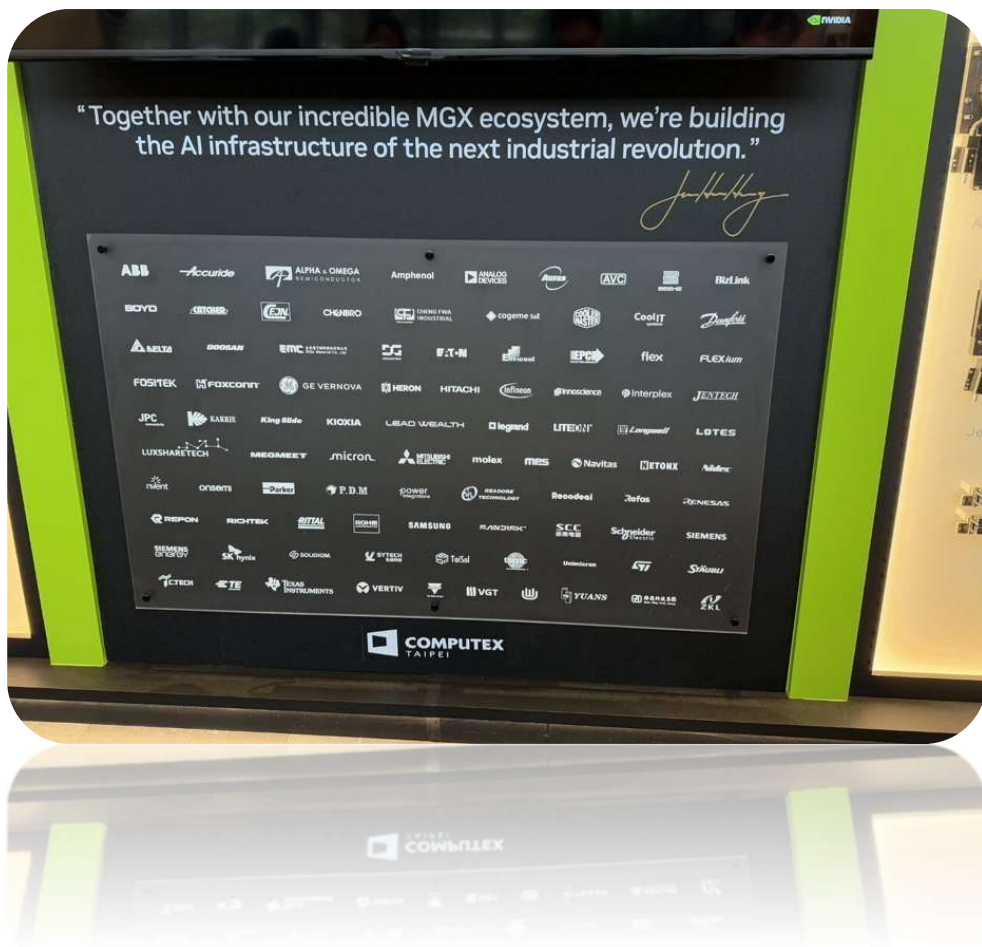
(Company Code: 3338)

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- This presentation contains forward-looking statement. Such forwardlooking information may be affected by significant risks and uncertainties, assumptions or other factors that may differ materially between Company's actual result and the information contained in this presentation.

Agenda

- 01 **2026 Q1 Financial Results**
- 02 **Business Outlook**
- 03 **Q & A**



01

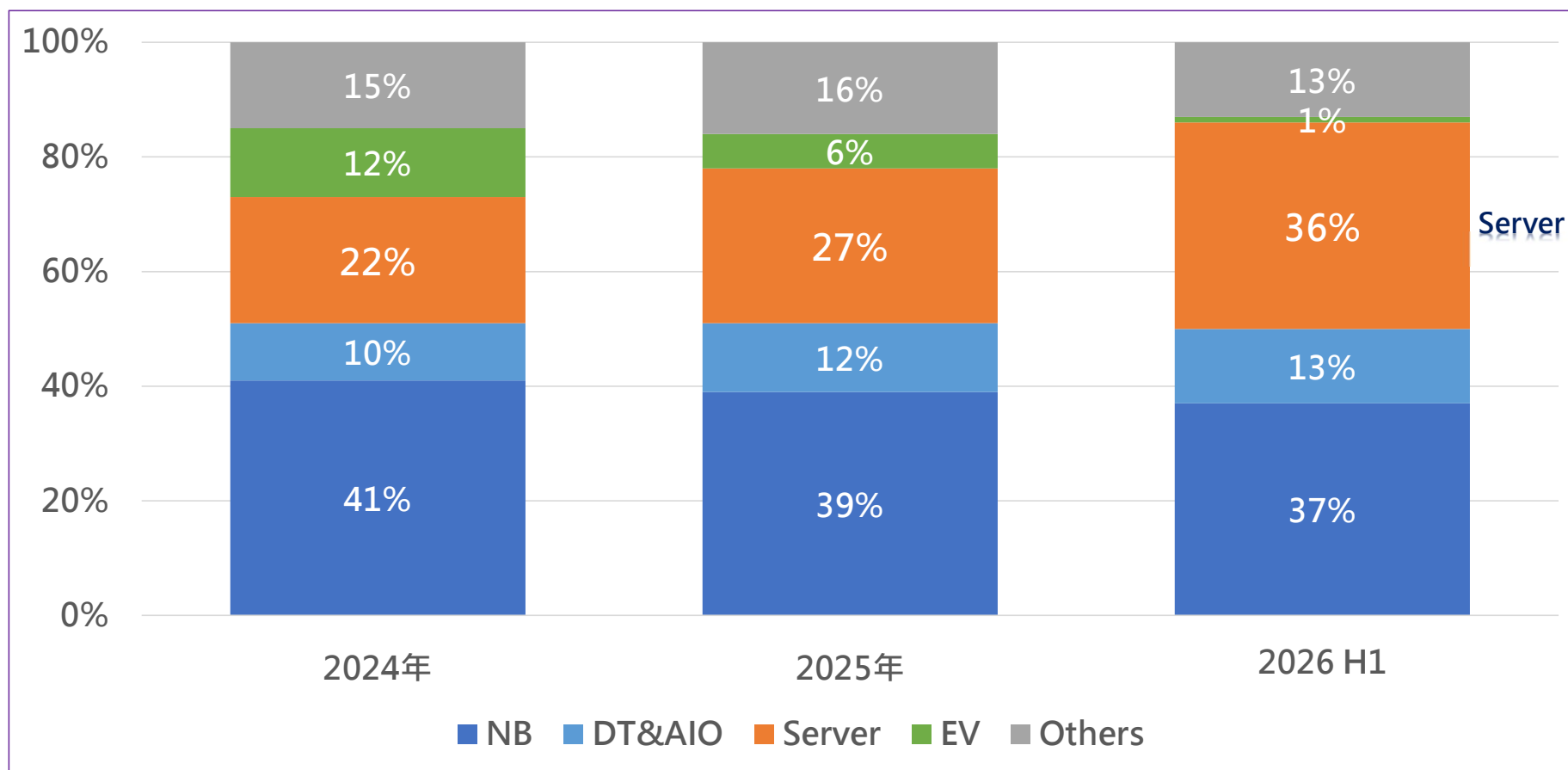
2026 Q1 Financial Results

Consolidated Income Statement

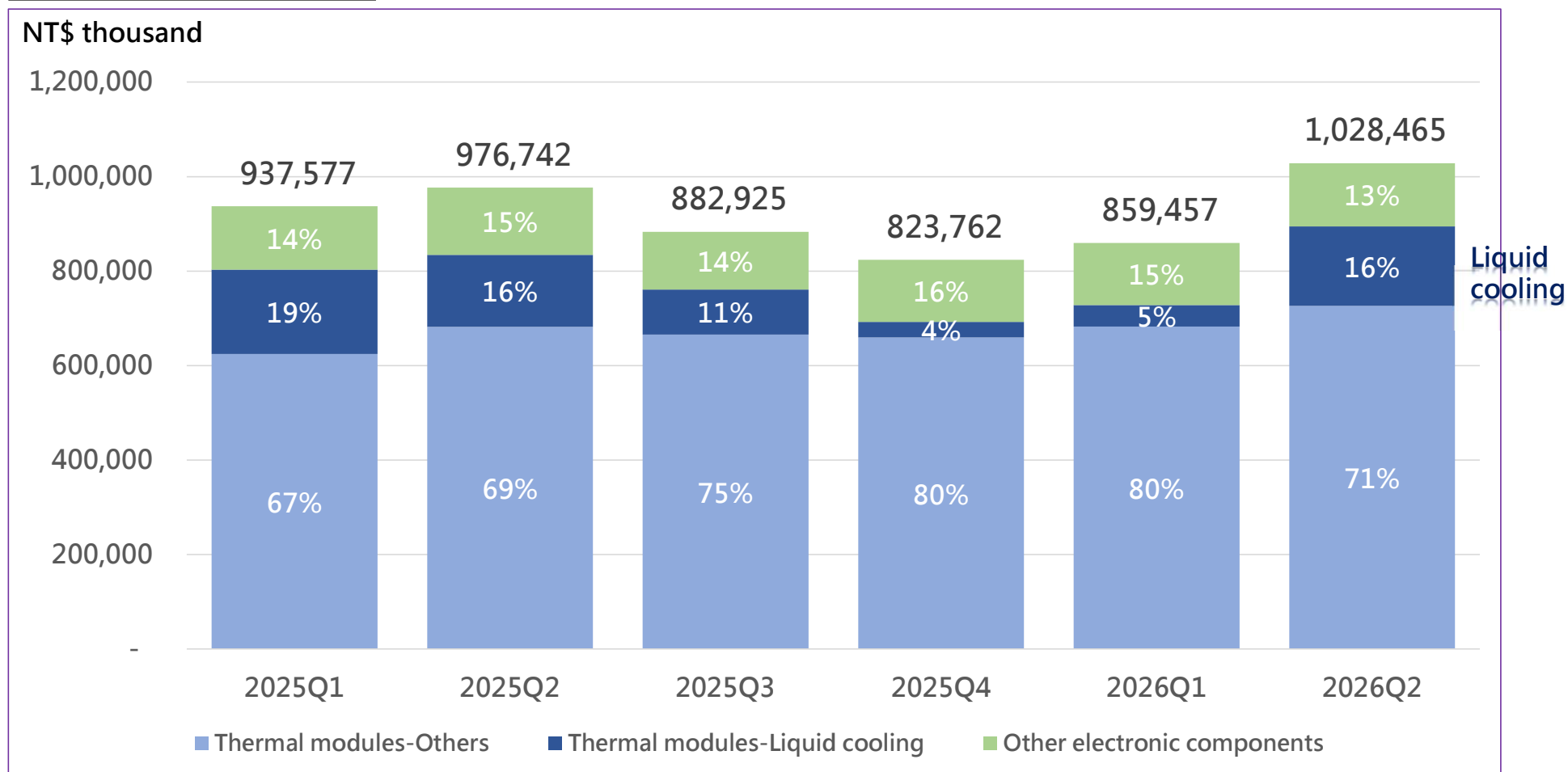
NT\$ thousand

	2026.01~03		2025.10~12		QoQ	2025.01~03		YoY
Operating Revenue	859,457	100%	823,762	100%	4%	937,577	100%	-8%
Gross Profit	163,158	19%	176,513	21%		186,294	20%	
Operating Expenses	136,399	16%	140,253	17%		130,859	14%	
Operating Income	26,759	3%	36,260	4%		55,435	6%	
Non-operating Income & Expenses	(998)	0%	(1,482)	0%		13,693	1%	
Income Before Income Tax	25,761	3%	34,778	4%	-26%	69,128	7%	-63%
Income Tax Expenses	2,499	0%	4,190	0%		16,192	2%	
Net Income	23,262	3%	30,588	4%		52,936	5%	
Income attributable to : Owners of the parent	23,262	3%	30,588	4%	-24%	52,936	5%	-56%
EPS (NT\$)	0.27		0.36			0.61		

Sales Revenue by Segment %



Sales Revenue by Merchandise %



02

Business Outlook

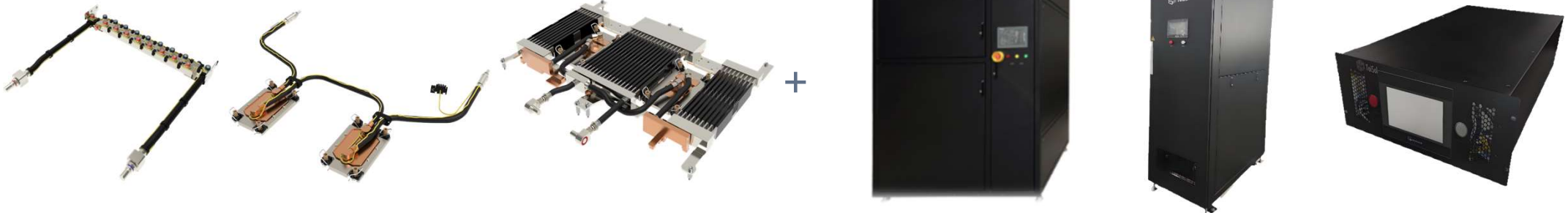


Leading the Green Computing Revolution: Liquid Cooling for NVIDIA's Next-Gen Platforms



End-to-End Liquid Cooling Integration—from Components to CDU Systems

TaiSol and NVIDIA are co-developing a 2.6 MW L2L CDU engineered for next-generation NVIDIA MGX platforms.



NVIDIA B300

NVIDIA B300

NVIDIA R200

Inner Manifold

CPU Liquid Cooling Module

DIMM Liquid Cooling Module

**In-Row 2.6MW
Liquid Cooling CDU
(800VDC)**

**In-Row CDU (L2L)
200~500kW**

**In Rack CDU (L2L)
120~250 kW**

01 Advanced Thermal Technologies

- Cold Plates | Heat Pipes | Vapor Chambers | Precision Welding
- Built for reliability and high-heat-flux applications



02 High-Performance Liquid Cooling Modules

- Integrated cold plates, manifolds, piping, and quick-disconnects
- Designed for NVIDIA and other leading high-performance liquid cooling platforms



03 Data Center Liquid Cooling Systems

- 2.6 MW L2L cooling capacity, supporting 800 VDC architectures
- Complete liquid cooling solutions—from modules to full CDU systems

Rising AI Rack Power → Accelerating Liquid Cooling Adoption → **TaiSol Expands from Modules to High-Power CDUs and Rack-Level Liquid Cooling Integration**

AI Revolution: 800VDC Liquid Cooling CDU for NVIDIA Platforms TaiSol

As AI rack power surges, TaiSol is advancing system-level liquid cooling with an 800VDC CDU built for NVIDIA platforms.



TaiSol advances next-generation AI data centers with high-power 800VDC L2L CDU technology and end-to-end fluid system integration.

2.6 MW Cooling Capacity

- Built for AI-scale heat loads
- Proven system integration

800 VDC

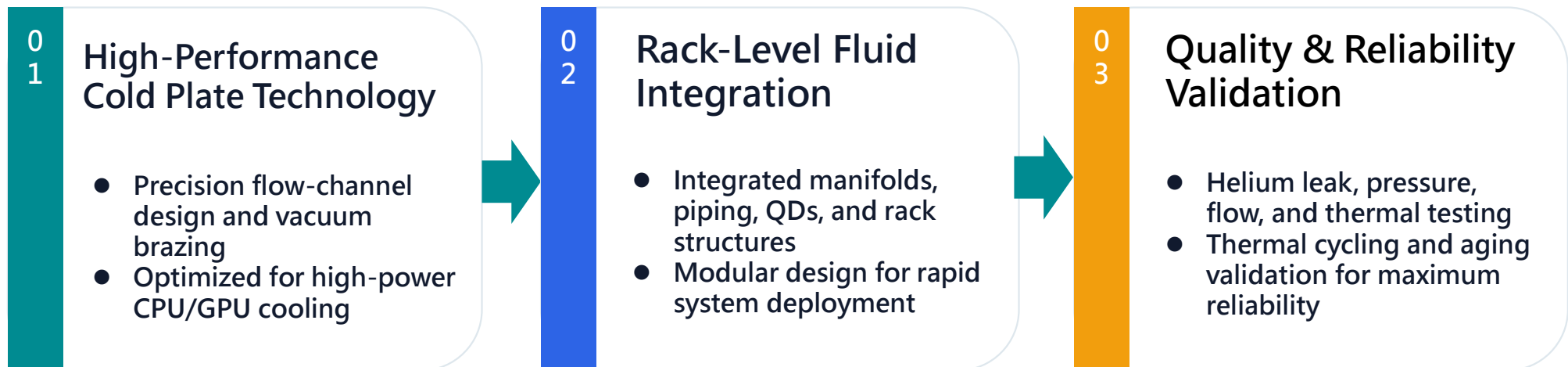
- Supports next-gen architectures
- Raises technical barriers and competitiveness

Validated for Reliable Production

- Pressure | Leak | Thermal Testing
- Accelerated supply-chain deployment and time-to-market

AI Data Center Power Surge Accelerates Liquid Cooling Adoption

AI power is rising. Liquid cooling is essential. TaiSol is ready to power the next generation of AI computing.



One-Stop AI Liquid Cooling, Faster to Mass Production

End-to-End Liquid Cooling: From Core Components to System-Level Integration



From core components to high-density systems and all-in-one liquid cooling modules, TaiSol delivers scalable solutions across diverse power levels.

01 Liquid Cooling Module for AI Servers (8 cards)

Total Power: 4.53 kW

8 x GPU and CPU
2 x Switch
2 x PSU

02 GPU + Switch Liquid Cooling Solution

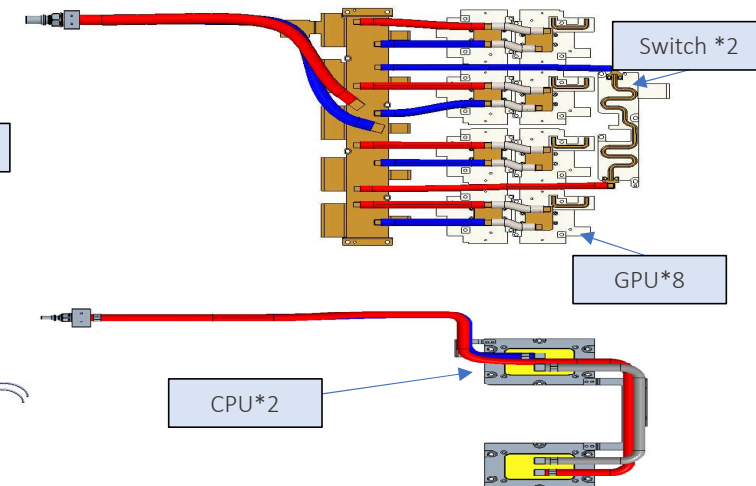
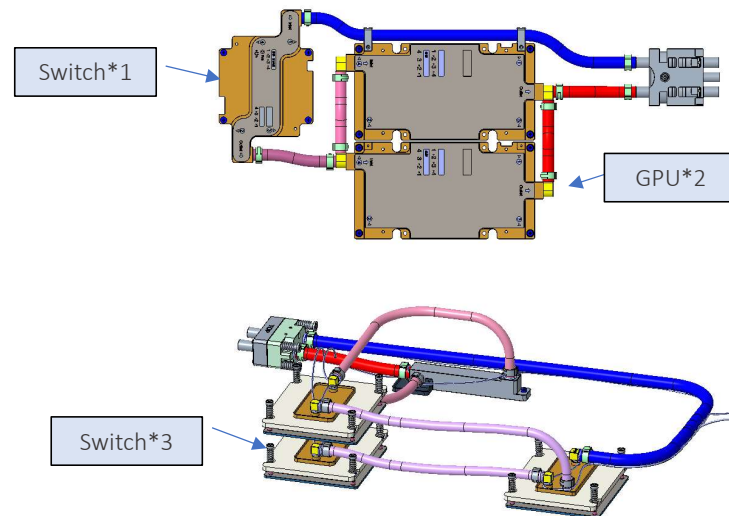
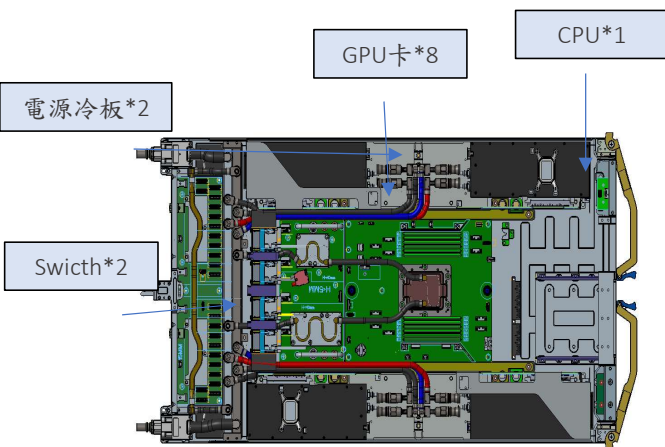
Total Power: 2.58 kW

2 x CPU
4 x Switch

03 All-in-One Liquid Cooling Module

Total Power: 3.43 kW

8 x GPU and 2 x CPU
4 x Switch



End-to-End Liquid Cooling: From Core Components to System-Level Integration



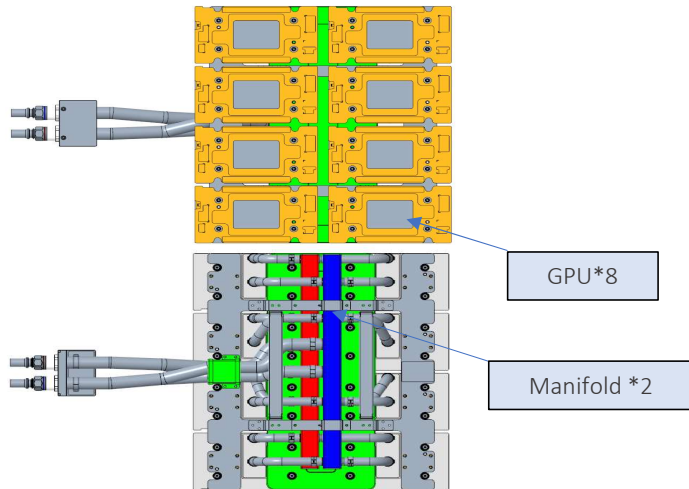
From core components to high-density systems and all-in-one liquid cooling modules, TaiSol delivers scalable solutions across diverse power levels.

04 Rack-Level 8-GPU Liquid Cooling Module

Total Power: 6.80 kW

8 x GPU

Inner Manifold



05 All-in-One Liquid Cooling Module

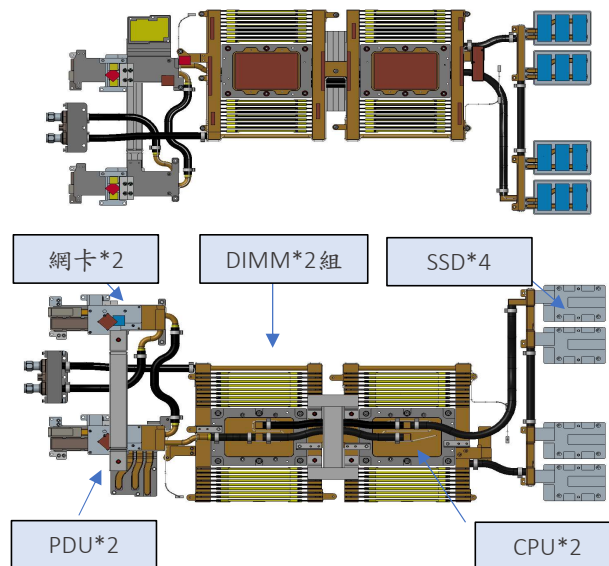
Total Power: 2.67 kW

Dual-GPU and 32 x DIMM

PDU Rack Power Distribution

NIC High-Speed SmartNIC

4 x NVMe SSD

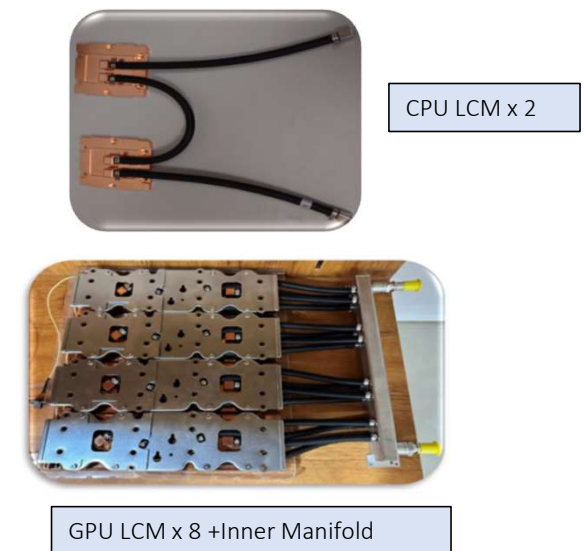


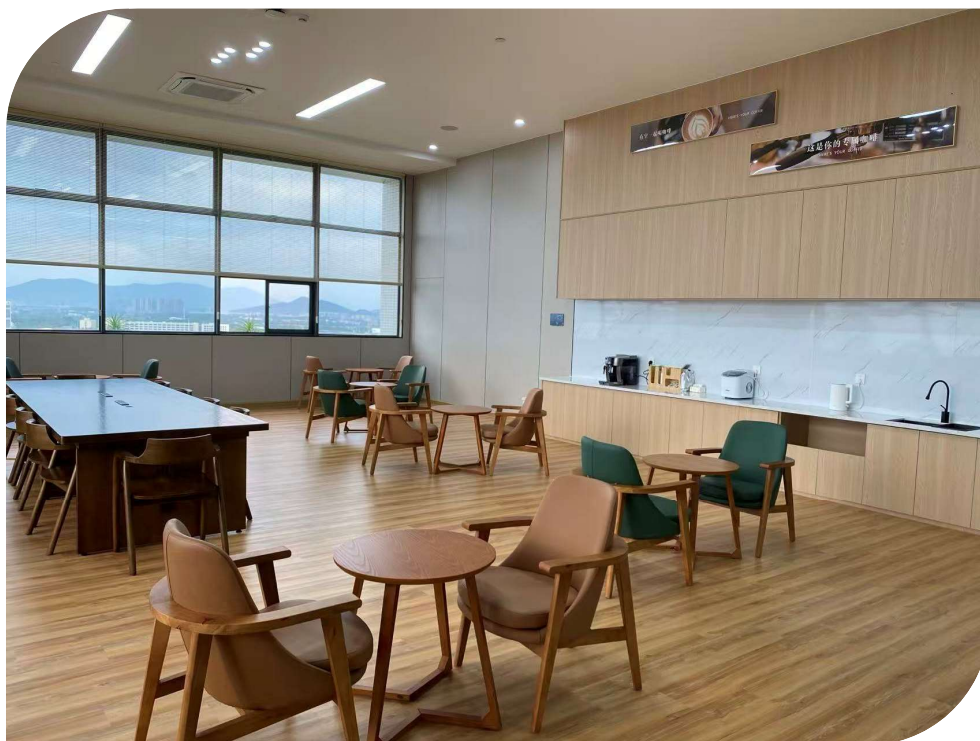
06 AMD Instinct™ MI355 Liquid Cooling Module

Total Power: 1.22 kW

2 x AMD EPYC™ CPU

8 x AMD MI355 GPU





03

Q & A

Thanks!